## **Development of metal-less bamboo wheelchair** Metal-less wheelchair with both strength and bamboo feel that can pass through airport security

We have developed a metal-less bamboo wheelchair with a wheelchair manufacturer, Sun-so'ing, based in Oita Prefecture and Japan Airlines International (JAL). Normally, wheelchair users who need to fly must undergo extra procedures such as body search at the airport security, since ordinary wheelchairs contain metal parts. Using the metal-less bamboo wheelchairs, they can remain seated during airport security screening. The JIS fatigue strength test for manually propelled wheelchairs is very strict, and the initial type of plastic parts that supported the wheels easily broke.

To overcome this problem, we have developed a two-point support system in the wheel portion to ensure the durability of the product without using metal parts, and have passed the JIS test. Other innovations such as easy-to-use footrests and brakes are also developed. The metal-less bamboo wheelchairs are already in service for passengers at Haneda, Oita, and Itami airports.



One-point support system (left) and two-point support system (right) of the frame



JAL rental whealchair counter at Haneda airport

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## **0.5 nm ultra-thin gate dielectric film** Contributes to low power operation of integrated circuits

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An ultra-thin gate dielectric film is developed using epitaxially grown crystalline  $HfO_2$  in place of amorphous SiO<sub>2</sub>. Owing to the large dielectric constant of crystalline  $HfO_2$  which is 5 times larger than that of amorphous SiO<sub>2</sub>, an ultra-thin electrical thickness of 0.5 nm is achieved by a 2.5 nm-thick epitaxial  $HfO_2$  film. The leakage current is 6 orders lower than SiO<sub>2</sub>. This technology is applicable to LSI manufacturing without difficulty, because it was developed based on the crystallization mechanism using LSI tools. Ultra-thin dielectric films contribute to the supply voltage reduction and thus the low power operation of integrated circuits.



(Left) Transmission electron microscope image of epitaxial  $HfO_2$  film on Si substrate (Right) Advantages of the epitaxial  $HfO_2$ /Si structure in the scaling of effective oxide thickness and reduction of gate leakage